

# Electric Drive Semiconductor Manufacturing (EDSM) Center

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Powerex, Inc.

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Project ARRAVT030



#### **Timeline**

Project start date: 12 Mar 2010

Project end date: 30 Sep 2012

Percent complete: 90+%

#### **Budget**

- Total project funding
  - DOE share: \$6,049,581.00
  - Powerex share: \$2,592,678.00

#### **Barriers**

- Equipment integration
- Material handling
- Agility to meet variety of products and industry standards
- Transition from prototype to production
- Process control

#### **Partners**

- No partners in grant award
- Leveraging existing customer and supplier relationships

# **"OWEREX"** Project Overview

- Powerex corporate offices in Youngwood, PA (near Pittsburgh)
- 250+ employees
- 120,000 square feet of facilities
- Design and manufacture
  - Rectifiers and Thyristors
  - Custom Modules
  - Integrated Power Products
- Markets include: automotive/ vehicle, transportation, wind, power generation & distribution,/ motor control, energy conservation











# **#OWEREX** Project Objectives/Relevance

#### **Objective:**

Powerex will modify its existing facility to house an integrated Electric Drive Semiconductor Manufacturing (EDSM) Center capable of producing over 100,000 electric drive semiconductor devices annually.

- EDSM Facility Provide a facility capable of meeting all EDSM project objectives
- Manufacturing Center Provide capability to produce, at a minimum, 100,000 electric drive semiconductor devices annually
- Reliability Center Provide the capability to fully test and qualify semiconductor device performance and reliability
- **Prototype Center** Provide the capability to develop new semiconductor device concepts through prototyping. This capability will reduce risk associated with new semiconductor device performance and reduce risk associated with high-volume manufacturing of new devices.

## **\*\*CWEREX** Approach – Phases & Milestones

#### Phased into existing facility

Maintain continuity of current operations and reduce risk

#### Phases of implementation

- Phase 1
  - Construct 10,000 sq ft class 10,000 clean room
  - Install & integrate manufacturing center equipment and processes
- Phase 2
  - Relocate existing prototype equipment into clean room
- Phase 3
  - Install reliability center equipment in space vacated by prototype equipment move
- Phase 4
  - Demonstrate capability through Low Rate Initial Production

MILESTONE	DATE	STATUS
Clean room installation complete	Nov 2011	Complete
Manufacturing Center equipment installed	Nov 2012	Complete
Prototype Center equipment moved to clean room	<b>Dec 2012</b>	Complete
Low Volume production resumes in new clean room	Jan 2012	Complete
Reliability Center equipment installed	Jan 2012	Complete
Manufacturing Center process demonstrated	Jun 2012	Open
Reliability Center capability demonstrated	Jun 2012	Open

# **\*\*CWEREX** Approach – Project Scope

#### **Modifications of existing Powerex facility**

- 10,120 ft<sup>2</sup> (940 m<sup>2</sup>)
- 40% to 60% relative humidity control
- 22C +/- 2C temperature control
- Class 10,000 manufacturing areas

#### **Manufacturing Center**

- 6,070 ft<sup>2</sup> (565 m<sup>2</sup>)
- Capable of producing 100,000 units/year in 2015

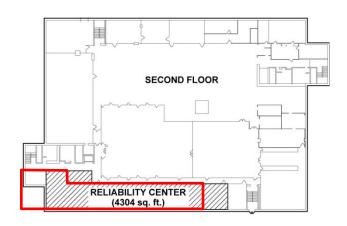
#### **Prototype Center**

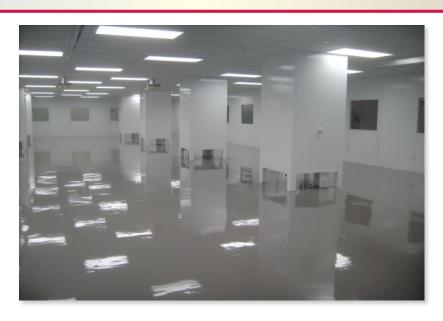
- 4,050 ft<sup>2</sup> (375m<sup>2</sup>)
- Utilizing existing Powerex equipment

#### **Reliability Center**

- 4,300 ft<sup>2</sup> (400m<sup>2</sup>)
- Capable of testing to automotive standards





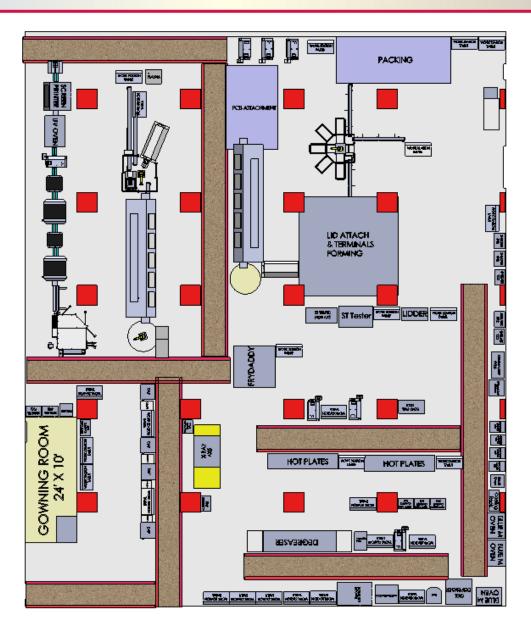


- Finished Steel City room Nov 3, 2011
- Equipment moved in Nov 4, 2011



- Production moved to clean room Dec 19-30, 2011
- Production started Jan 4, 2012

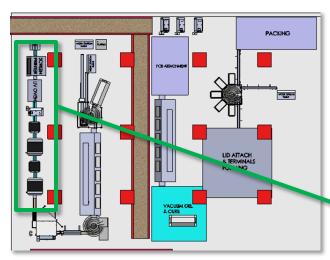
# **CWEREX** Approach – Process & Equipment



# **Steel City Clean Room Layout**

Manufacturing Center in same room with Prototype Center.

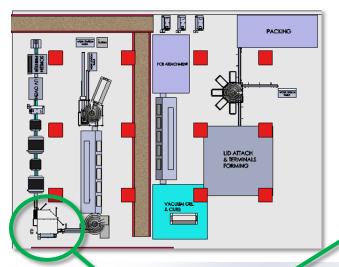
This concept will allow us to better utilize all machines and cells.

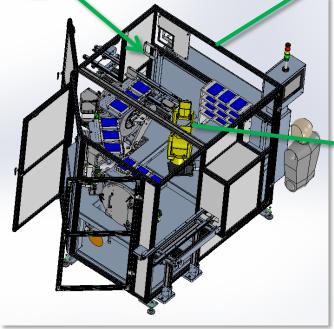


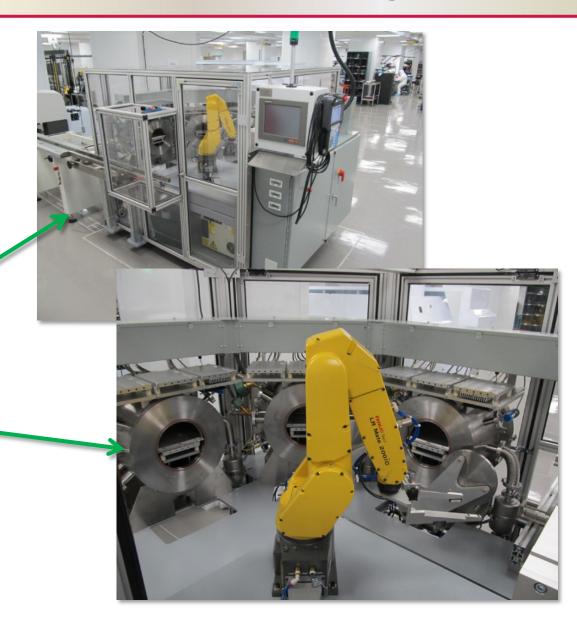
# First equipment moved to Powerex Cleanroom:

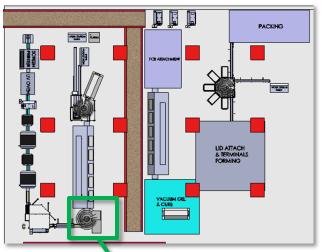
- Base plates de-stacker
- Solder mask printer
- UV curing oven
- Wire bonder
- Solder paste dispensers (2)
- Components pick & place (2)



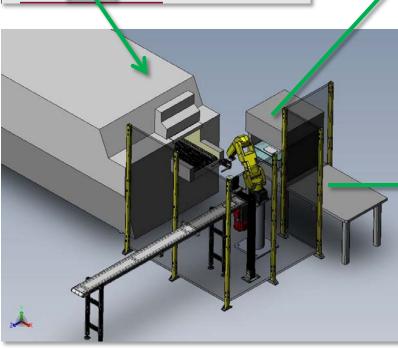




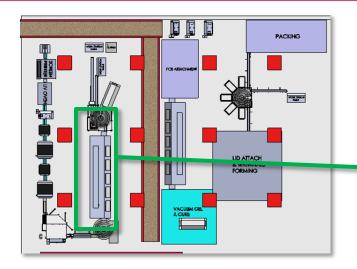




100% acoustic microscope inspection after reflow soldering

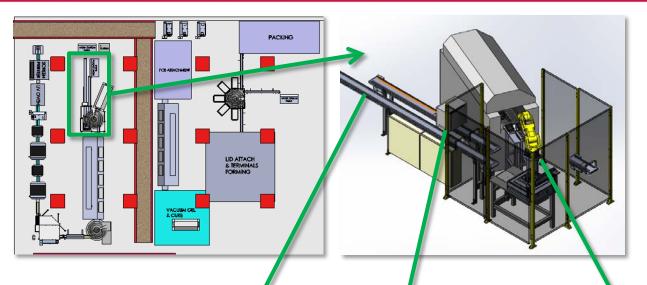








Solder flux cleaners placed in clean room



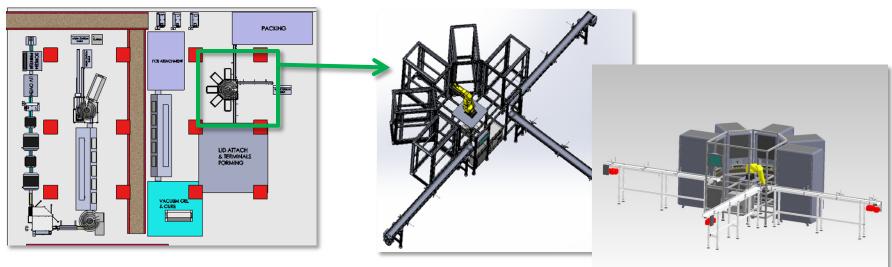
# Housing Assembly Cell

- Cleaner unloading
- RTV dispensing
- Housing placing
- Screws attachment
- Placing on the curing oven belt



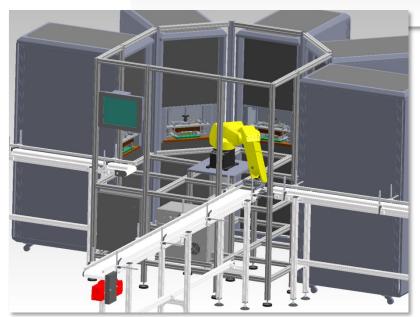






# Acceptance Testing Integrated Cell

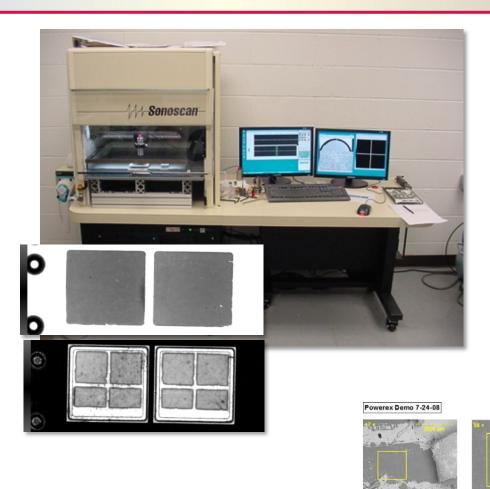
- 5 or 6 testers in individual racks
- Standardized (exchangeable) contacts fixtures installed by robot
- Tested devices placed on hotplates plus in and out contact fixtures by robot
- Testers controlled by PC
- Data automatically collected and stored





- Equipment to perform 27 tests for automotive reliability including
  - Electrical testing
  - Environment testing
  - Lifetime testing
  - Mechanical testing
- Analytical equipment to troubleshoot and control processes

## **CWEREX** Accomplishments – Reliability Center

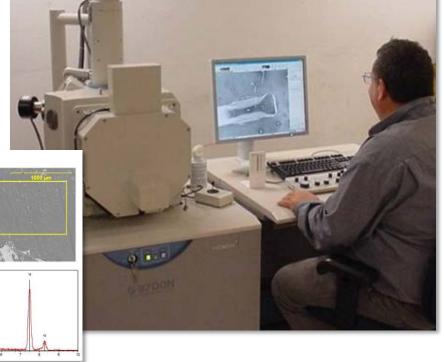


#### Acoustic Microscope

- Ultrasound imaging
- Solder void and lamentation analysis

#### **Electron Microscope**

- Micro imaging
- Micro Elemental Analysis (EDS)



## **\*\*COMEREX** Accomplishments – Reliability Center

- Single-Axis Vibration (Sinusoidal and Random)
- Burn-in (High Temp Reverse Bias, High Temp Gate Bias)
- Highly Accelerated Stress Testing (HAST)
- Intermittent Operating Life (IOL)
- Temperature Cycling
- Moisture Resistance
- Low Temp Storage
- Partial Discharge
- Wire Bond Pull
- Doe Shear



#### **COMEREX** Collaboration & Coordination

- No partners are directly involved in execution of grant
- Strong, collaborative partnerships with many critical material suppliers and service providers
- Long-standing relationships with many customers in electric drive industry
- Long-standing teaming arrangements with universities, federal agencies and companies engaged in state-ofthe-art power module research



#### In 2012

- Complete Manufacturing Center equipment integration and process demonstration
- Demonstrate full capability of Reliability Center
- Complete and close out project

# **CWEREX** Project Summary

- Grant awarded in March 2010
- Objective: create capacity to design through prototyping, produce and test 100,000 semiconductor power modules annually
- 2-year phased approach to permit risk reduction and implementation in existing plant without impacting on-going production operations
- Project is meeting all technical goals on schedule and within budget
- Clean room complete, equipment installed, working on final process demonstration